

Docket No. 151966US2PCT

IN RE APPLICATION OF: Hayashi OTSUKI, et al. -

SERIAL NO: 09/530,588

FILED: May 5, 2000

FOR: METHOD OF FORMING SEMICONDUCTOR WIRING STRUCTURES

COMMISSIONER FOR PATENTS  
ALEXANDRIA, VIRGINIA 22313

SIR:

Transmitted herewith is an amendment in the above-identified application.

- ☒ No additional fee is required
- ☐ Small entity status of this application under 37 C.F.R. §1.9 and §1.27 is claimed.
- ☒ Additional documents filed herewith: Supplemental Declaration

The Fee has been calculated as shown below:

CLAIMS	CLAIMS REMAINING		HIGHEST NUMBER PREVIOUSLY PAID	NO. EXTRA CLAIMS	RATE	CALCULATIONS
TOTAL	19	MINUS	46	0	x \$18 =	\$0.00
INDEPENDENT	3	MINUS	6	0	x \$86 =	\$0.00
		<input type="checkbox"/> MULTIPLE DEPENDENT CLAIMS			+ \$290 =	\$0.00
		TOTAL OF ABOVE CALCULATIONS				\$0.00
		<input type="checkbox"/> Reduction by 50% for filing by Small Entity				\$0.00
		<input type="checkbox"/> Recordation of Assignment			+ \$40 =	\$0.00
		TOTAL				\$0.00

- ☐ A check in the amount of \$0.00 is attached.
- ☐ Credit card payment form is attached to cover the fees in the amount of \$0.00
- ☒ Please charge any additional Fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.
- ☒ If these papers are not considered timely filed by the Patent and Trademark Office, then a petition is hereby made under 37 C.F.R. §1.136, and any additional fees required under 37 C.F.R. §1.136 for any necessary extension of time may be charged to Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

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Appl. No. 09/530,588  
Reply to Office Action of July 18, 2003



DOCKET NO. 2312-0866-2PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF: :  
HAYASHI OTSUKI ET AL. : GROUP: 2814  
SERIAL NO: 09/530,588 : EXAMINER: QUACH, T.  
FILED: MAY 5, 2000 :  
FOR: METHOD OF FORMING SEMICONDUCTOR WIRING STRUCTURES

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AMENDMENT UNDER 37 CFR 1.116

COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

SIR:

In response to the Office Action mailed July 18, 2003, please amend the above-identified patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Amendments to the Abstract** begin on page 7 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.